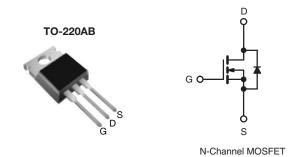


### **Power MOSFET**

| PRODUCT SUMMARY                 |                        |      |  |  |  |
|---------------------------------|------------------------|------|--|--|--|
| V <sub>DS</sub> (V)             | 400                    |      |  |  |  |
| $R_{DS(on)}\left(\Omega\right)$ | V <sub>GS</sub> = 10 V | 0.55 |  |  |  |
| Q <sub>g</sub> (Max.) (nC)      | 63                     |      |  |  |  |
| Q <sub>gs</sub> (nC)            | 9.0                    |      |  |  |  |
| Q <sub>gd</sub> (nC)            | 32                     |      |  |  |  |
| Configuration                   | Single                 |      |  |  |  |



### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

| ORDERING INFORMATION |            |
|----------------------|------------|
| Package              | TO-220AB   |
| Lead (Pb)-free       | IRF740PbF  |
| Lead (Pb)-free       | SiHF740-E3 |
| SnPb                 | IRF740     |
| SIPD                 | SiHF740    |

| <b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted) |                         |   |                                   |                  |          |  |
|--|-------------------------|---|-----------------------------------|------------------|----------|--|
| PARAMETER  |                         |   | SYMBOL                            | LIMIT            | UNIT     |  |
| Drain-Source Voltage   |                         |   | $V_{DS}$                          | 400              | V        |  |
| Gate-Source Voltage  |                         |   | $V_{GS}$                          | ± 20             | v        |  |
| Continuous Drain Current   | V -140.V                | T <sub>C</sub> = 25 °C                        | - I <sub>D</sub>                  | 10               | А        |  |
|  | V <sub>GS</sub> at 10 V | $T_C = 25 \degree C$<br>$T_C = 100 \degree C$ |                                   | 6.3              |          |  |
| Pulsed Drain Current <sup>a</sup>  |                         |   | I <sub>DM</sub>                   | 40               |          |  |
| Linear Derating Factor   |                         |   |                                   | 1.0              | W/°C     |  |
| Single Pulse Avalanche Energy <sup>b</sup>                                       |                         |   | E <sub>AS</sub>                   | 520              | mJ       |  |
| Repetitive Avalanche Current <sup>a</sup>  |                         |   | I <sub>AR</sub>                   | 10               | Α        |  |
| Repetitive Avalanche Energy <sup>a</sup>   |                         |   | E <sub>AR</sub>                   | 13               | mJ       |  |
| Maximum Power Dissipation $T_C = 25  ^{\circ}C$                                  |                         |   | $P_{D}$                           | 125              | W        |  |
| Peak Diode Recovery dV/dt <sup>c</sup>   |                         |   | dV/dt                             | 4.0              | V/ns     |  |
| Operating Junction and Storage Temperature Range                                 |                         |   | T <sub>J</sub> , T <sub>stg</sub> | - 55 to + 150    | - °C     |  |
| Soldering Recommendations (Peak Temperature) for 10 s                            |                         |   |                                   | 300 <sup>d</sup> |          |  |
| Mounting Torque  | 6-32 or M3 screw        |   |                                   | 10               | lbf ⋅ in |  |
| Mounting Torque  |                         |   |                                   | 1.1              | N⋅m      |  |

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 9.1 mH,  $R_q$  = 25  $\Omega$ ,  $I_{AS}$  = 10 A (see fig. 12).
- c.  $I_{SD} \le 10 \text{ A}$ ,  $dI/dt \le 120 \text{ A/}\mu\text{s}$ ,  $V_{DD} \le V_{DS}$ ,  $T_{J} \le 150 \,^{\circ}\text{C}$ .
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



| THERMAL RESISTANCE RATINGS          |                   |      |      |      |  |  |
|-------------------------------------|-------------------|------|------|------|--|--|
| PARAMETER                           | SYMBOL            | TYP. | MAX. | UNIT |  |  |
| Maximum Junction-to-Ambient         | R <sub>thJA</sub> | -    | 62   |      |  |  |
| Case-to-Sink, Flat, Greased Surface | R <sub>thCS</sub> | 0.50 | -    | °C/W |  |  |
| Maximum Junction-to-Case (Drain)    | R <sub>thJC</sub> | -    | 1.0  |      |  |  |

| PARAMETER                                 | SYMBOL                | TEST (  | MIN.   | TYP. | MAX. | UNIT  |       |
|---|-----------------------|---|--|------|------|-------|-------|
| Static                                    |                       |   |  |      |      |       |       |
| Drain-Source Breakdown Voltage            | V <sub>DS</sub>       | $V_{GS} = 0$  | ) V, I <sub>D</sub> = 250 μA                   | 400  | -    | -     | V     |
| V <sub>DS</sub> Temperature Coefficient   | $\Delta V_{DS}/T_{J}$ | Reference   | to 25 °C, I <sub>D</sub> = 1 mA                | -    | 0.49 | -     | V/°C  |
| Gate-Source Threshold Voltage             | V <sub>GS(th)</sub>   | $V_{DS} = V$  | ' <sub>GS</sub> , I <sub>D</sub> = 250 μA      | 2.0  | -    | 4.0   | V     |
| Gate-Source Leakage                       | I <sub>GSS</sub>      | VG  | <sub>SS</sub> = ± 20 V                         | -    | -    | ± 100 | nA    |
| Zoro Cata Valtago Drain Current           |                       | V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 0 V  |  | -    | -    | 25    |       |
| Zero Gate Voltage Drain Current           | I <sub>DSS</sub>      | V <sub>DS</sub> = 320 V, V  | V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C | -    | -    | 250   | μA    |
| Drain-Source On-State Resistance          | R <sub>DS(on)</sub>   | V <sub>GS</sub> = 10 V  | $I_D = 6.0 A^b$                                | -    | -    | 0.55  | Ω     |
| Forward Transconductance                  | 9 <sub>fs</sub>       | $V_{DS} = 5$  | 60 V, I <sub>D</sub> = 6.0 A <sup>b</sup>      | 5.8  | -    | -     | S     |
| Dynamic                                   |                       |   |  |      |      |       |       |
| Input Capacitance                         | C <sub>iss</sub>      | V   | V <sub>GS</sub> = 0 V,                         |      | 1400 | -     |       |
| Output Capacitance                        | C <sub>oss</sub>      | V <sub>DS</sub> = 25 V,<br>f = 1.0 MHz, see fig. 5  |  | 1    | 330  | -     | pF    |
| Reverse Transfer Capacitance              | $C_{rss}$             |   |  | 1    | 120  | -     |       |
| Total Gate Charge                         | Qg                    |   | 1 10 A V 200 V                                 | ı    | -    | 63    |       |
| Gate-Source Charge                        | $Q_{gs}$              | $V_{GS} = 10 \text{ V}$ $I_D = 10 \text{ A}, V_{DS} = 320 \text{ V},$                             |  | -    | -    | 9.0   | nC    |
| Gate-Drain Charge                         | $Q_{gd}$              |   | see fig. 6 and 13 <sup>b</sup>                 | -    | -    | 32    | 1     |
| Turn-On Delay Time                        | t <sub>d(on)</sub>    | $V_{DD}$ = 200 V, $I_D$ = 10 A $R_g$ = 9.1 Ω, $R_D$ = 20 Ω, see fig. 10 <sup>b</sup>              |  | -    | 14   | -     | ns ns |
| Rise Time                                 | t <sub>r</sub>        |   |  | -    | 27   | -     |       |
| Turn-Off Delay Time                       | t <sub>d(off)</sub>   |   |  | -    | 50   | -     |       |
| Fall Time                                 | t <sub>f</sub>        |   |  | -    | 24   | -     |       |
| Internal Drain Inductance                 | L <sub>D</sub>        | Between lead,<br>6 mm (0.25") fro   | Between lead,<br>6 mm (0.25") from             |      | 4.5  | -     |       |
| Internal Source Inductance                | L <sub>S</sub>        | package and center of die contact   |  | -    | 7.5  | -     | h nH  |
| Drain-Source Body Diode Characteristic    | s                     |   |  |      |      |       |       |
| Continuous Source-Drain Diode Current     | I <sub>S</sub>        | 1   | MOSFET symbol                                  |      | -    | 10    |       |
| Pulsed Diode Forward Current <sup>a</sup> | I <sub>SM</sub>       | showing the integral reverse p - n junction diode   |  | -    | -    | 40    | А     |
| Body Diode Voltage                        | V <sub>SD</sub>       | $T_J = 25  ^{\circ}\text{C}, I_S = 10  \text{A}, V_{GS} = 0  \text{V}^{\text{b}}$                 |  | -    | -    | 2.0   | V     |
| Body Diode Reverse Recovery Time          | t <sub>rr</sub>       | $T_J = 25 \text{ °C}, I_F = 10 \text{ A, dl/dt} = 100 \text{ A/µs}^b$                             |  | -    | 370  | 790   | ns    |
| Body Diode Reverse Recovery Charge        | Q <sub>rr</sub>       |   |  | -    | 3.8  | 8.2   | μC    |
| Forward Turn-On Time                      | t <sub>on</sub>       | Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> ) |  |      |      | 1 _ \ |       |

#### **Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

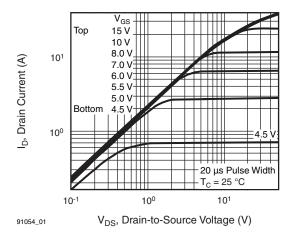


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

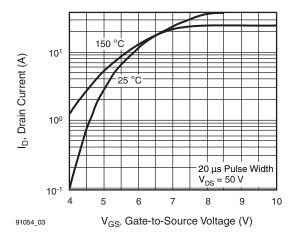


Fig. 3 - Typical Transfer Characteristics

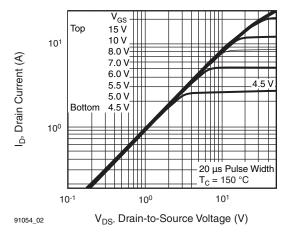


Fig. 2 - Typical Output Characteristics,  $T_C$  = 150 °C

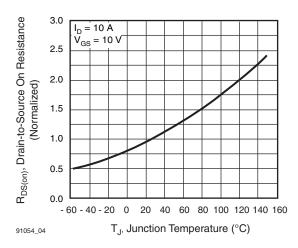
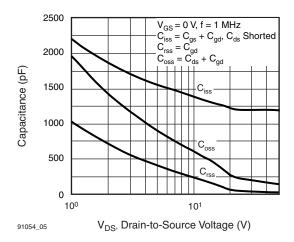


Fig. 4 - Normalized On-Resistance vs. Temperature





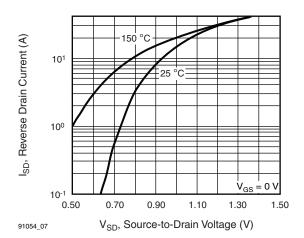
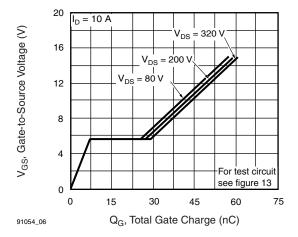


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

Fig. 7 - Typical Source-Drain Diode Forward Voltage



 $10^{3}$ Operation in this area limited by R<sub>DS(on</sub> 10<sup>2</sup> ID, Drain Current (A) 2 10 1 T<sub>C</sub> = 25 °C 5 = 150 °C 2 Single Pulse 0.1 10 0.1 V<sub>DS</sub>, Drain-to-Source Voltage (V) 91054\_08

Fig. 6 - Typical Gate Charge vs. Drain-to-Source Voltage

Fig. 8 - Maximum Safe Operating Area





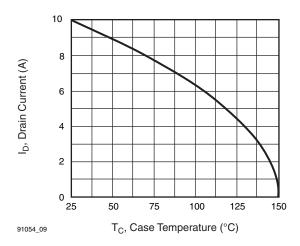


Fig. 9 - Maximum Drain Current vs. Case Temperature

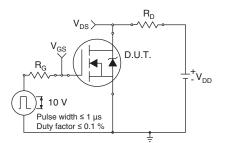


Fig. 10a - Switching Time Test Circuit

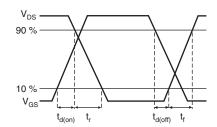


Fig. 10b - Switching Time Waveforms

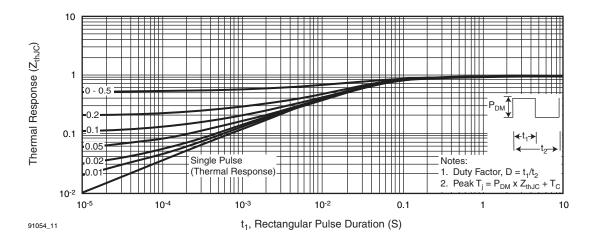


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



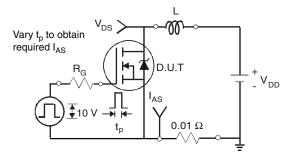


Fig. 12a - Unclamped Inductive Test Circuit

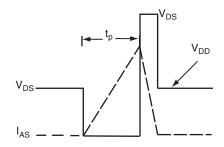


Fig. 12b - Unclamped Inductive Waveforms

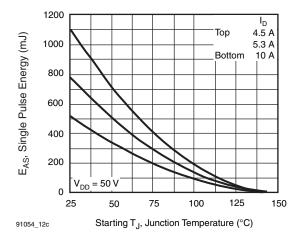


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

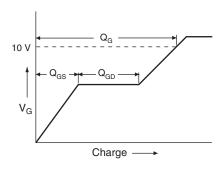


Fig. 13a - Basic Gate Charge Waveform

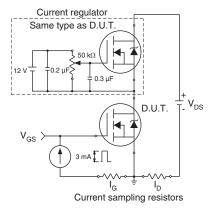
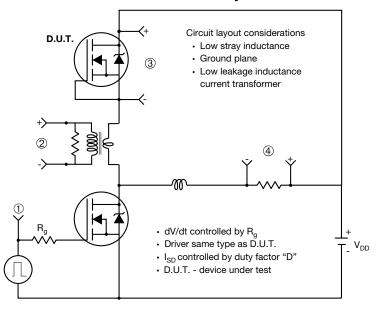


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



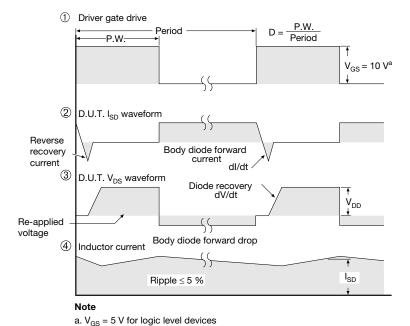


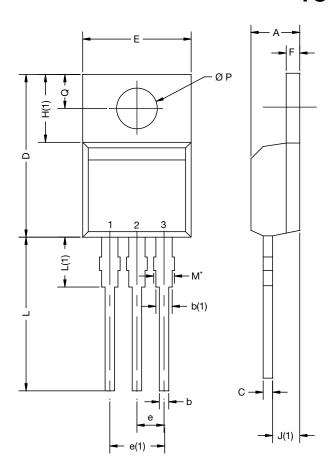
Fig. 14 - For N-Channel

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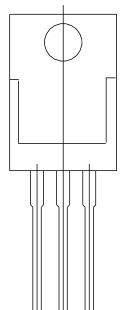
# TO-220-1



|  | MILLIMETERS |       | INC   | ICHES |  |
|--|-------------|-------|-------|-------|--|
| DIM.   | MIN.        | MAX.  | MIN.  | MAX.  |  |
| Α  | 4.14        | 4.70  | 0.163 | 0.185 |  |
| b  | 0.69        | 1.02  | 0.027 | 0.040 |  |
| b(1)   | 1.14        | 1.73  | 0.045 | 0.068 |  |
| С  | 0.36        | 0.61  | 0.014 | 0.024 |  |
| D  | 14.33       | 15.85 | 0.564 | 0.624 |  |
| Е  | 9.96        | 10.52 | 0.392 | 0.414 |  |
| е  | 2.41        | 2.67  | 0.095 | 0.105 |  |
| e(1)   | 4.88        | 5.28  | 0.192 | 0.208 |  |
| F  | 0.43        | 1.40  | 0.017 | 0.055 |  |
| H(1)   | 6.10        | 6.48  | 0.240 | 0.255 |  |
| J(1)   | 2.41        | 2.92  | 0.095 | 0.115 |  |
| L  | 13.36       | 14.40 | 0.526 | 0.567 |  |
| L(1)   | 3.33        | 4.04  | 0.131 | 0.159 |  |
| ØΡ   | 3.53        | 3.94  | 0.139 | 0.155 |  |
| Q  | 2.59        | 3.00  | 0.102 | 0.118 |  |
| ECN: X15-0003-Rev. A, 19-Jan-15<br>DWG: 6031 |             |       |       |       |  |

#### Notes

- M\* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM
- Outline conforms to JEDEC<sup>®</sup> outline TO-220AB with exception of dimension F



Revison: 19-Jan-15 1 Document Number: 66542



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Revision: 02-Oct-12 Document Number: 91000

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